

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Kwang-Choon Chung	07/02/2007
Hyun-Nam Cho	07/02/2007
Myoung-Seon Gong	07/02/2007
Yi-Sup Han	07/02/2007
Jeong-Bin Park	07/02/2007
Dong-Hun Nam	07/02/2007
Seong-Yong Uhm	07/02/2007
Young-Kwan Seo	07/02/2007

RECEIVING PARTY DATA

Name:	Inktec Co., Ltd.
Street Address:	1124, Shingil-dong, Kyeongki-do
City:	Ansan
State/Country:	KOREA, REPUBLIC OF
Postal Code:	425-839

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11815745

CORRESPONDENCE DATA

Assignment

Fax Number: (412)471-4094

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 4124718815

Email: webblaw@webblaw.com

Correspondent Name: Richard L. Byrne

Address Line 1: 700 Koppers Building; 436 Seventh Avenue

Address Line 4: Pittsburgh, PENNSYLVANIA 15219

ATTORNEY DOCKET NUMBER:

5038-072538

NAME OF SUBMITTER:

Richard L. Byrne 28,498 5038-072538

Signature:

/richard l byrne/

Date:

08/07/2007

Total Attachments: 3

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RECEIPT INFORMATION

EPAS ID: PAT339340

Receipt Date: 08/07/2007

Fee Amount: \$40

TO: RICHARD L. BYRNE COMPA .700 KOPPERS BUILDING; 436 SEVENTH AVENUE

PATENT ASSIGNMENT

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08/07/2007
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OP. \$40.00 11815745

TO: RICHARD L. BYRNE COMPA(700 KOPPERS BUILDING; 436 SI 'NTH AVENUE

NAME OF SUBMITTER:	Richard L. Byrne 28,498 8038-072538
Total Attachments: 3 source=ASSIGN#page1.tif source=ASSIGN#page2.tif source=ASSIGN#page3.tif	

ASSIGNMENT

WHEREAS We,

CHUNG, Kwang-Choon

of 9-711 Gaepo4Woosung APT., Dogok-dong, Kangnam-gu, Seoul 135-270,

CHO, Hyun-Nam

of 807-302 Suri APT., 1151-1 Sanbon-dong, Gunpo-city, Kyeongki-do 435-040,

GONG, Myoung-Seon

of 904 Hyundai4APT., Ilwon-dong, Kangnam-gu, Seoul 135-230,

HAN, Yi-Sup

of 503-1402 Dongmun APT. Ilсан-dong, Ilсан-gu, Goyang-city, Kyeongki-do 411-310,

PARK, Jeong-Bin

of 514-207 Jugong5 APT. Gojan-2dong, Danwon-gu, Ansan-city,

Kyeongki-do 425-722,

NAM, Dong-Hun

of 888-14 Doksan-3dong, Keumcheon-gu Seoul 153-010,

UHM, Seong-Yong

of 119-503 Cheoncheon APT. Cheoncheon-dong, Jangan-gu, Suwon-city,

Kyeongki-do 440-710, and

SEO, Young-Kwan

of 104-1516 Dongbo APT. Geomo-dong, Siheung-city, Kyeongki-do 429-702

(hereinafter referred to as "ASSIGNORS");

have invented certain new and useful improvements in:

**ORGANIC SILVER COMPLEXES, THEIR PREPARATION METHODS
AND THEIR METHODS FOR FORMING THIN LAYERS**

which claims priority to KR Application No. 10-2005-0011478, filed on 07 February 2005,
KR Application No. 10-2005-0011631, filed on 11 February 2005, KR Application No.

10-2006-0011083, filed on 06 February 2006 and for which We are about to file an application for Letters Patent of the United States;

AND WHEREAS, INKTEC CO., LTD. (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Republic of Korea, having a place of business at 1124, Shingil-dong, Ansan-city, Kyeongki-do 425-839, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behalf of ASSIGNEE, its successors and assigns; and We do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: July 2, 2007

정광춘

CHUNG, Kwang-Choon

Date: July 2, 2007

최현남

CHO, Hyun-Nam

Date: July 2, 2007

M. S. Gong

GONG, Myoung-Seon

Date: July 2, 2007

한이섭

HAN, Yi-Sup

Date: July 2, 2007

박정빈

PARK, Jeong-Bin

Date: July 2, 2007

남동훈

NAM, Dong-Hun

Date: July 2, 2007

엄성용

UHM, Seong-Yong

Date: July 2, 2007

서영관

SEO, Young-Kwan

TO: RICHARD L. BYRNE COMPA 700 KOPPERS BUILDING; 436 ST NTH AVENUE

ASSIGNMENT

ASSIGNOR:

CHENG, Kwang-Chang

of 9-711 Gungwan Road, Taipei, Taiwan, Republic of China

ASSIGNOR:

CHEN, Hsiang-Ping

ASSIGNOR:

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CHEN, Hsiang-Ping

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CHEN, Hsiang-Ping

**ORGANIC SYSTEM COMPLEXES, THEIR PREPARATION METHODS
AND USES METHODS FOR FORMING THE SAME**

which claim priority to KR Application No. 10-2005-001473, filed on 07 February 2005
KR Application No. 10-2005-001474, filed on 11 February 2005, KR Application No.

TO: RICHARD L. BYRNE COMPA 700 KOPPERS BUILDING; 436 ST NTH AVENUE

AND WHEREAS THE SAID ASSIGNEE HAS BEEN ADVISED BY THE SAID PATENT OFFICE THAT THE SAID PATENT IS IN THE NAME OF THE SAID ASSIGNEE AND IS SUBJECT TO THE SAID ASSIGNMENT;

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TO: RICHARD L. BYRNE COMPA 700 KOPPERS BUILDING; 436 ST NTH AVENUE

<i>[Handwritten Signature]</i>	<i>[Handwritten Signature]</i>
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